BFG67; BFG67/XR

NPN 8 GHz wideband transistors

Rev. 05 — 23 November 2007

Product data sheet

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NPN 8 GHz wideband transistors

BFG67; BFG67/X; BFG67/XR

FEATURES

- High power gain
- Low noise figure
- · High transition frequency
- · Gold metallization ensures excellent reliability.

APPLICATIONS

Wideband applications in the GHz range, such as satellite TV tuners and portable RF communications equipment.

DESCRIPTION

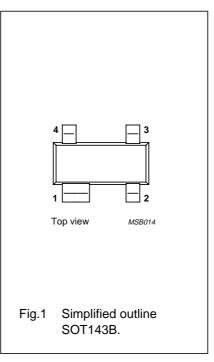
NPN silicon transistor in a 4-pin, dual-emitter SOT143B plastic package. Available with in-line emitter pinning (BFG67) and cross emitter pinning (BFG67/X). Version with reverse pinning (BFG67/XR) also available on request.

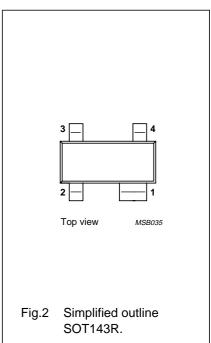
MARKING

CODE
V3%
%MV
V26

PINNING

PIN	DESCRIPTION			
PIN	BFG67	BFG67/X	BFG67/XR	
1	collector	collector	collector	
2	base	emitter	emitter	
3	emitter	base	base	
4	emitter	emitter	emitter	





QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V _{CEO}	collector-emitter voltage	open base	_	10	V
I _C	collector current (DC)		_	50	mA
P _{tot}	total power dissipation	T _s ≤ 65 °C	_	300	mW
C _{re}	feedback capacitance	I _C = i _c = 0; V _{CB} = 8 V; f = 1 MHz	0.5	_	pF
f _T	transition frequency	I _C = 15 mA; V _{CE} = 8 V; f = 500 MHz	8	_	GHz
G _{UM}	maximum unilateral power gain	I _C = 15 mA; V _{CE} = 8 V; T _{amb} = 25 °C; f = 1 GHz	17	_	dB
F	noise figure	$\Gamma_{\text{S}} = \Gamma_{\text{opt}}$; $I_{\text{C}} = 5$ mA; $V_{\text{CE}} = 8$ V; $T_{\text{amb}} = 25$ °C; $f = 1$ GHz	1.3	_	dB
		$\Gamma_{\text{S}} = \Gamma_{\text{opt}}$; $I_{\text{C}} = 5$ mA; $V_{\text{CE}} = 8$ V; $T_{\text{amb}} = 25$ °C; $f = 2$ GHz	2.2	_	dB

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	20	V
V_{CEO}	collector-emitter voltage	open base	-	10	V
V _{EBO} emitter-base voltage		open collector	_	2.5	V
I _C	collector current (DC)		_	50	mA
P _{tot}	total power dissipation	T _s ≤ 65 °C; see Fig.3; note 1	_	380	mW
T _{stg}	storage temperature range		–65	150	°C
Tj	junction temperature		_	175	°C

Note

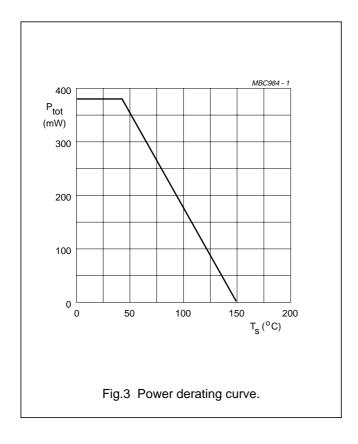
1. T_s is the temperature at the soldering point of the collector pin.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-s}	thermal resistance from junction to soldering point	note 1	290	K/W

Note

1. T_s is the temperature at the soldering point of the collector pin.



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CHARACTERISTICS

 $T_j = 25$ °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector leakage current	V _{CB} = 5 V; I _E = 0	_	_	50	nA
h _{FE}	DC current gain	I _C = 15 mA; V _{CE} = 5 V	60	100	_	
f _T	transition frequency	I _C = 15 mA; V _{CE} = 8 V; f = 500 MHz	_	8	_	GHz
C _c	collector capacitance	I _E = i _e = 0; V _{CB} = 8 V; f = 1 MHz	_	0.7	_	pF
C _e	emitter capacitance	$I_C = I_C = 0$; $V_{EB} = 0.5 \text{ V}$; $f = 1 \text{ MHz}$	_	1.3	_	pF
C _{re}	feedback capacitance	$I_C = I_C = 0$; $V_{CB} = 8 \text{ V}$; $f = 1 \text{ MHz}$	_	0.5	_	pF
G _{UM}	maximum unilateral power gain; note 1	$I_C = 15 \text{ mA}; V_{CE} = 8 \text{ V};$ $T_{amb} = 25 ^{\circ}\text{C}; f = 1 \text{ GHz}$	_	17	_	dB
		I_{C} = 15 mA; V_{CE} = 8 V; T_{amb} = 25 °C; f = 2 GHz	_	10	_	dB
F	noise figure	$\Gamma_{\rm s}$ = $\Gamma_{\rm opt}$; $I_{\rm C}$ = 5 mA; $V_{\rm CE}$ = 8 V $T_{\rm amb}$ = 25 °C; f = 1 GHz	_	1.3	_	dB
		$\Gamma_{\rm s}$ = $\Gamma_{\rm opt}$; $I_{\rm C}$ = 15 mA; $V_{\rm CE}$ = 8 V; $T_{\rm amb}$ = 25 °C; f = 1 GHz	_	1.7	_	dB
		$I_C = 5 \text{ mA}; V_{CE} = 8 \text{ V};$ $T_{amb} = 25 \text{ °C}; f = 2 \text{ GHz}; Z_S = 60 \Omega$	_	2.5	_	dB
		I_{C} = 15 mA; V_{CE} = 8 V; T_{amb} = 25 °C; f = 2 GHz; Z_{S} = 60 Ω	_	3	_	dB

Note $\text{1. } G_{UM} \text{ is the maximum unilateral power gain, assuming } S_{12} \text{ is zero and } G_{UM} = 10 \log \frac{\left|S_{21}\right|^2}{\left(1-\left|S_{11}\right|^2\right)\left(1-\left|S_{22}\right|^2\right)} \text{ dB. }$

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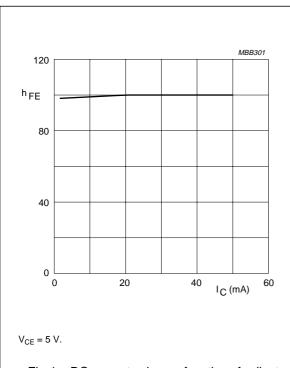
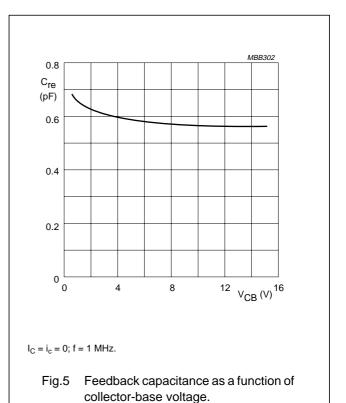
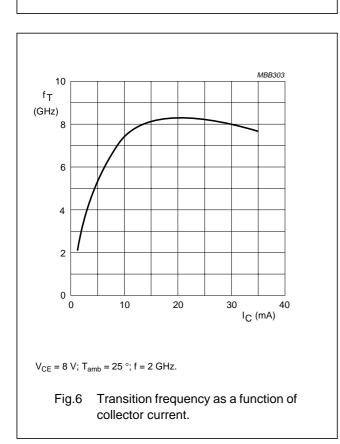
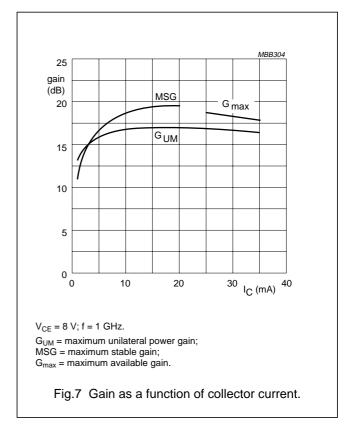


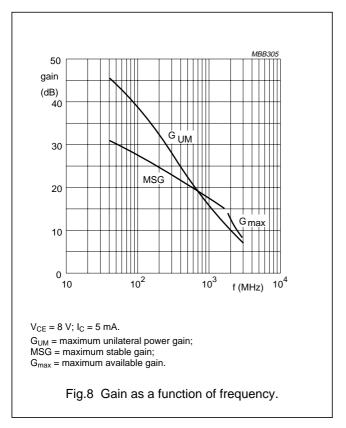
Fig.4 DC current gain as a function of collector current.

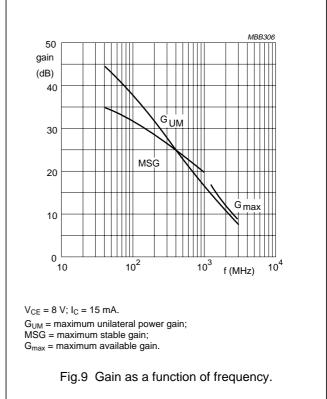


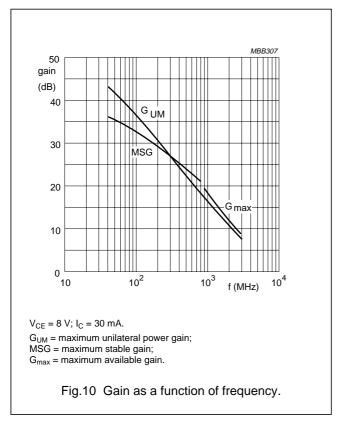


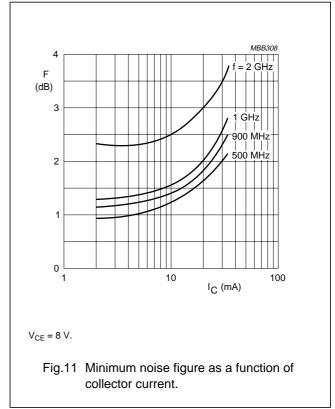


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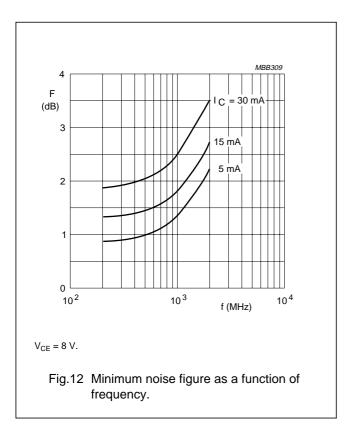






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BFG67; BFG67/X; BFG67/XR

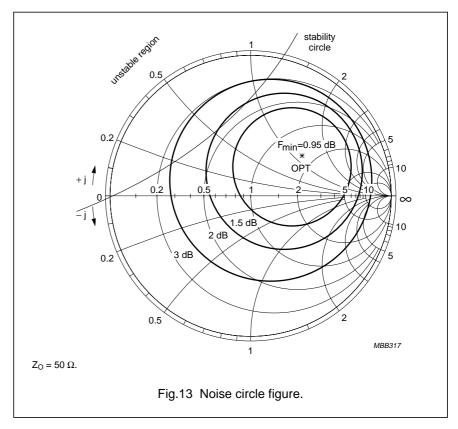


BFG67/X

f (MHz)	V _{CE} (V)	I _C (mA)
500	8	5

Noise Parameters

F _{mi}	in	Gamm	a (opt)	R _n /50
(dE	3)	(mag)	(ang)	K _n /50
0.95		0.455	33.8	0.288



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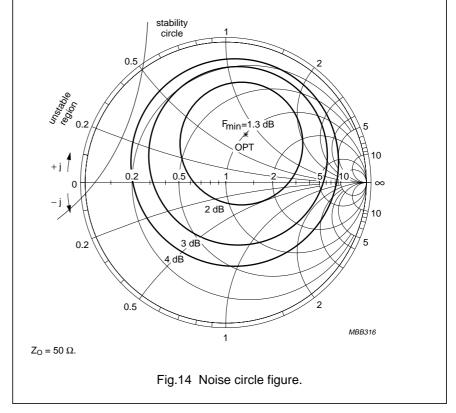
BFG67; BFG67/X; BFG67/XR

BFG67/X

f	V _{CE}	I _C
(MHz)	(V)	(mA)
1000	8	5

Noise Parameters

F _{min}	Gamm	R _n /50	
(dB)	(mag)	(ang)	K _n /30
1.3	0.375	65.9	0.304



BFG67/X

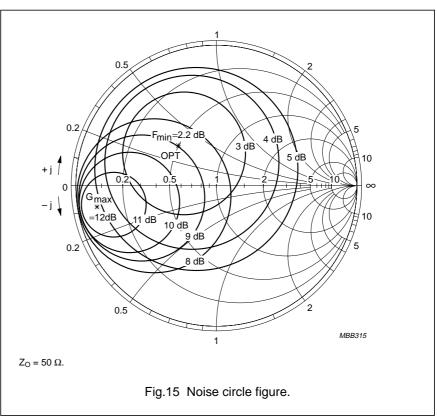
f (MHz)	V _{CE} (V)	I _C (mA)
2000	8	5

Noise Parameters

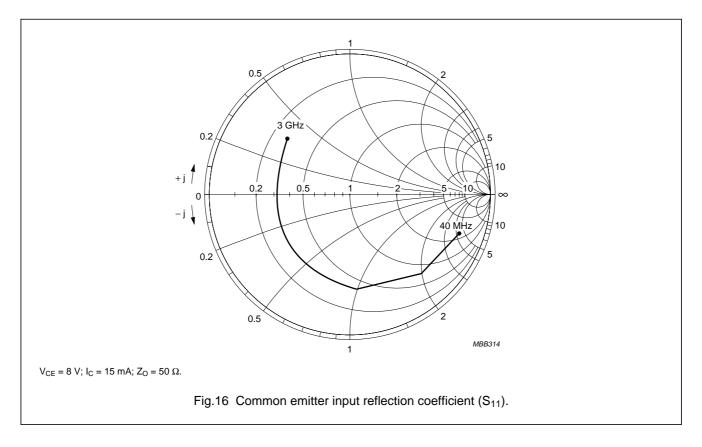
F _{min}	Gamm	a (opt)	D /50
(dB)	(mag)	(ang)	R _n /50
2.2	0.391	136.5	0.184

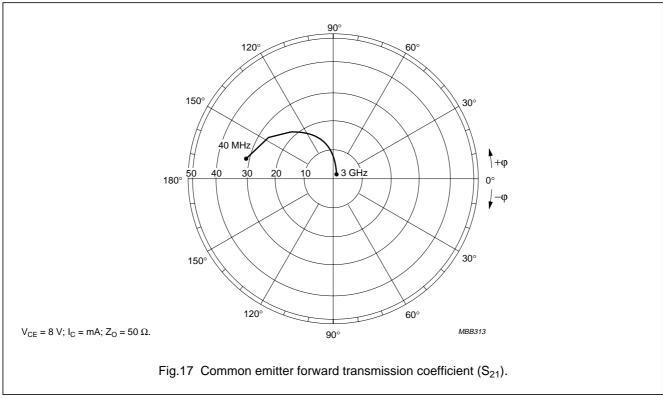
Average Gain Parameters

G _{MAX}	Gamma (max)						
(dB)	(mag)	(ang)					
12	0.839	-170					

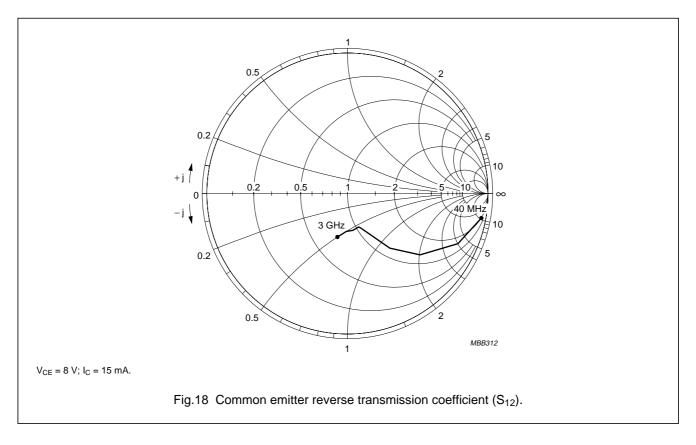


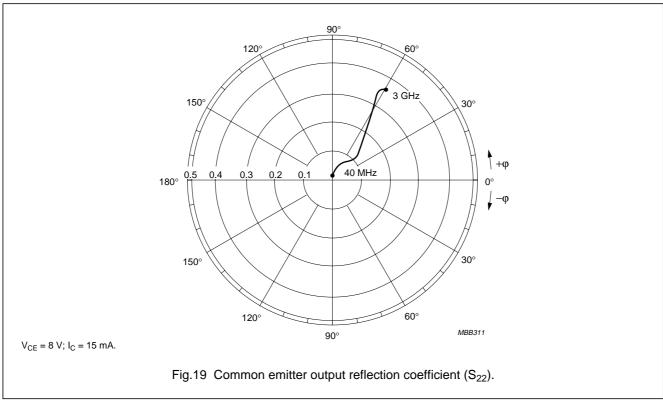
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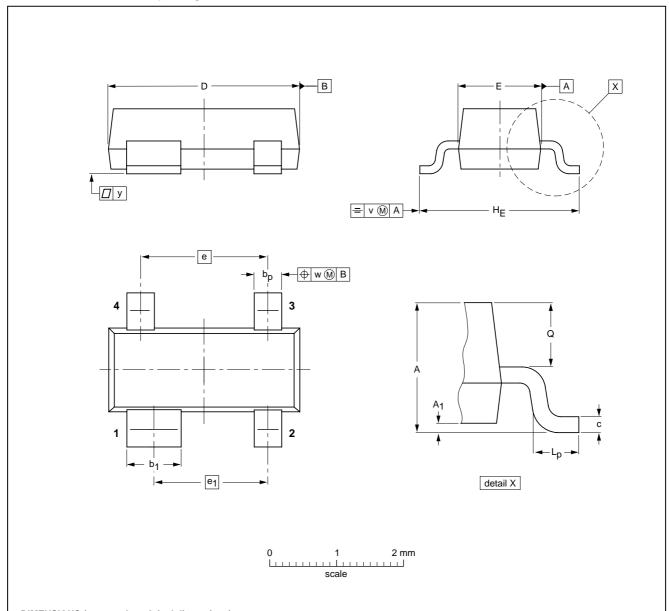
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PACKAGE OUTLINES

Plastic surface mounted package; 4 leads

SOT143B



DIMENSIONS (mm are the original dimensions)

U	NIT	A	A ₁ max	bp	b ₁	С	D	E	е	e ₁	HE	L _p	Q	v	w	у
n	nm	1.1 0.9	0.1	0.48 0.38	0.88 0.78	0.15 0.09	3.0 2.8	1.4 1.2	1.9	1.7	2.5 2.1	0.45 0.15	0.55 0.45	0.2	0.1	0.1

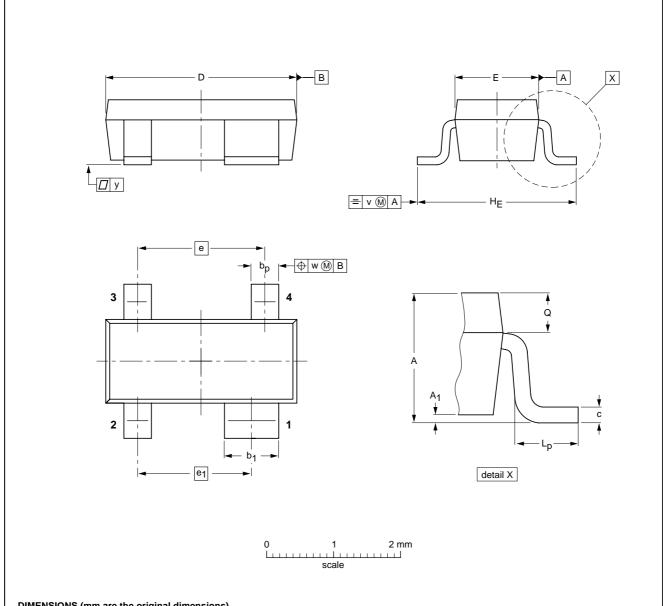
OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT143B					97-02-28

NPN 8 GHz wideband transistors

BFG67; BFG67/X; BFG67/XR

Plastic surface mounted package; reverse pinning; 4 leads

SOT143R



DIMENSIONS (mm are the original dimensions)

UNIT	A	A ₁ max	bp	b ₁	U	D	E	е	e ₁	HE	Lp	Q	v	w	у
mm	1.1 0.9	0.1	0.48 0.38	0.88 0.78	0.15 0.09	3.0 2.8	1.4 1.2	1.9	1.7	2.5 2.1	0.55 0.25	0.45 0.25	0.2	0.1	0.1

OUTLINE		REFER	ENCES	EUROPEAN ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	
SOT143R					97-03-10	

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Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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Revision history

Table 1. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BFG67_X_XR_N_5	20071123	Product data sheet	-	BFG67_X_XR_4
Modifications:	 Page 2; Table 	e Marking code; row 1 and 2 c	ode changed	
BFG67_X_XR_4 (9397 750 04349)	19981002	Product specification	-	BFG67_SERIES_3
BFG67_SERIES_3	19950901	Product specification	-	BFG67_SERIES_2
BFG67_SERIES_2	-	Product specification	-	BFG67_SERIES_1
BFG67_SERIES_1	-	-	-	-

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Date of release: 23 November 2007

Document identifier: BFG67_X_XR_N_5